0.5mm Pitch, 5.8mm above the board, vertical connectors for FPC

FH40 Series



Features

1. Reduction in connection man-hours (30% reduction compared to our conventional item)

Our unique actuator form enables the completion of both FPC insertion \sim joint in the same motion.

2. Prevention of half and diagonal joints

The side catcher for FPC positioning ensures accurate FPC insertion.

3. Durable structure and no lost actuator

The unique terminal form means the actuator is retained, even under rough operation conditions.

4. One-finger operation of the actuator

Proven (in several other Hirose's connectors!) Flip-Lock rotating actuator assures reliable mechanical and electrical connection with FPC, confirming it with a definite tactile feel.

5. Accepts standard FPC thickness

0.3mm thick standard Flexible Printed Circuit (FPC) can be used.

6. Board placement with automatic equipment

Flat upper surface and tape and reel packaging facilitate vacuum pick-up and placement. Standard reel packaging contains 1,000 connectors.

7. Halogen-free *

*As defined by IEC61249-2-21 Br-900ppm maximum, CI-900ppm maximum, CI + Br combined-1,500ppm maximum









Product Specifications

Ratings	Current rating : 0.5A DC(Note 1) Operating Temperature Range : -40 to + Voltage rating : 50Vrms AC Operating Humidity Range : Relative hum (No condition)			
Recommended FPC Thickness	0.3±0.05mm, Gold plated contact pads			
Item	Specification	Conditions		
1. Insulation resistance	500MΩ min.	100V DC		
2. Withstanding voltage	No flashover or insulation breakdown	150Vrms AC / 1 minute		
3. Contact resistance	$50m\Omega$ max. Including FPC and FFC conductor resistance	1mA, (DC or 1000Hz)		
4. Durability	Contact resistance : 50mΩ max. No damage, cracks, or parts dislocation	20 cycles		
5. Vibration	No electrical discontinuity of 1μ s or longer Contact resistance: $50m\Omega$ max. No damage, cracks, or parts dislocation	Frequency : 10 to 55Hz, single amplitude of 0.75mm, 10 cycles in each of the 3 axis.		
6. Shock	No electrical discontinuity of 1μ s or longer No damage, cracks, or parts dislocation Contact resistance : $50m\Omega$ max.	Acceleration of 981m/s ² , 6ms duaration, sine half-wave wavefrom 3 cycles in each of the 3 axis		
7. Humidity(Steady state)	Contact resistance : $50m\Omega$ max. Insulation resistance : $50M\Omega$ min. No damage, cracks, or parts dislocation	96 hours at 40°C and humidity of 90 to 95%		
8. Temperature Cycle	Contact resistance : $50m\Omega$ max. Insulation resistance : $50M\Omega$ min. No damage, cracks, or parts dislocation	Temperature : -40° C $\rightarrow +15^{\circ}$ C to $+35^{\circ}$ C $\rightarrow +105^{\circ}$ C $\rightarrow +15^{\circ}$ C to $+35^{\circ}$ C Time : 30 \rightarrow 2 to 3 \rightarrow 30 \rightarrow 2 to 3(minutes) 5 cycles		
9. Resistance to Soldering heat	No deformation of components affecting performance	Reflow : At the recommended temperature profile Manual soldering : 350°C±5°C for 5 seconds		

Note 1 : When passing the current through all of the contacts, use 70% of the rated current.

Note 2 : Includes temperature rise caused by current flow.

Note 3 : The term "storage" refers to products stored for a long period prior to mounting and use. The operating temperature and humidity range covers the non-conducting condition of installed connectors in storage, shipment or during transportation after board mounting.

Materials / Finish

Part	Material	Finish	Remarks	
Insulator	LCP	Color : Beige	UL94V-0	
Insulator	LOF	Color : Black	06940-0	
Contact	Phosphor bronze	Gold plated		

Product Number Structure

Refer to the chart below when determining the product specifications from the product number. Please select from the product numbers listed in this catalog when placing orders.

<u>FH 40 - 50S</u>	- <u>0.5</u> <u>SV</u> <u>(99)</u>
0000	4 6 6
 Series Name 	: FH
2 Series No.	: 40
3 Number of positions	: 10 to 80
4 Contact pitch	: 0.5mm
5 SV	: SMT vertical mounting type
6 Specifications standardPartial go (99)Partial gold pla	ld plating 1,000pcs/reel ating 500pcs/reel

Connector Dimensions





Note 1: The coplanarity of each terminal lead within specified dimension is 0.1mm Max.

Note 2 : Packaged on tape and reel only. Check packaging specification.

Note 3 : Slight variations in color of the plastic compounds do not affect form, fit or function of the connector.

Note 4 : After reflow, the terminal plating may change color, however this does not represent a quality issue.

					Unit : mm
Part No.	HRS No.	No. of Contacts	А	В	С
FH40-10S-0.5SV	580-2104-6	10	5.57	8.2	4.5
FH40-20S-0.5SV	580-2105-9	20	10.57	13.2	9.5
FH40-24S-0.5SV	580-2106-1	24	12.57	15.2	11.5
FH40-30S-0.5SV	580-2108-7	30	15.57	18.2	14.5
FH40-40S-0.5SV	580-2107-4	40	20.57	23.2	19.5
FH40-45S-0.5SV	580-2101-8	45	23.07	25.7	22
FH40-50S-0.5SV	580-2100-5	50	25.57	28.2	24.5
FH40-60S-0.5SV	580-2109-0	60	30.57	33.2	29.5
FH40-64S-0.5SV	580-2102-0	64	32.57	35.2	31.5
FH40-80S-0.5SV	580-2103-3	80	40.57	43.2	39.5

Note 1 : Tape and reel packaging (1,000 pcs/reel, 500 pcs/reel). Order by number of reels.

Recommended PCB mounting pattern and metal mask dimensions



Recommended metal mask thickness : t=0.15

Recommended FPC Dimensions

It is not recommended to mate FPC without tabs to this connector.



Note 1 : Stiffener dimension should be 3.5mm min., and X dimension should be 0.5mm for improved flexibility of FPC.

					Unit : mm
Part No.	HRS No.	No. of Contacts	С	D	E
FH40-10S-0.5SV	580-2104-6	10	4.5	5.5	7.1
FH40-20S-0.5SV	580-2105-9	20	9.5	10.5	12.1
FH40-24S-0.5SV	580-2106-1	24	11.5	12.5	14.1
FH40-30S-0.5SV	580-2108-7	30	14.5	15.5	17.1
FH40-40S-0.5SV	580-2107-4	40	19.5	20.5	22.1
FH40-45S-0.5SV	580-2101-8	45	22	23	24.6
FH40-50S-0.5SV	580-2100-5	50	24.5	25.5	27.1
FH40-60S-0.5SV	580-2109-0	60	29.5	30.5	32.1
FH40-64S-0.5SV	580-2102-0	64	31.5	32.5	34.1
FH40-80S-0.5SV	580-2103-3	80	39.5	40.5	42.1

Recommended FPC construction

1. Using Single-sided FPC



FPC : Flexible Printed Circuit

Material Name	Material	Material Thickness (µm)	
Covering film layer	Polyimide 1 mil thick.	(25)	
Cover adhesive		(25)	
Surface treatment	$0.2\mu m$ thick gold plated over 1 to $5\mu m$ nickel underplating	3	
Copper foil	Cu 1oz	35	
Base adhesive	Thermosetting adhesive	25	
Base film	Polyimide 1 mil thick	25	
Reinforcement material adhesive	Thermosetting adhesive	40	
Stiffene	Polyimide 7 mil thick	175	
	Total	303	

2. Using Double-sided FPC

FPC : Flexible Printed Circuit



* To prevent release of the FPC due to its bending, use of the double sided FPC with copper foil on the back side is NOT RECOMMENDED.

3. Using FFC FFC : Flexible Flat Cable Material Name Material Thickness (µm) Polyester film 12 Adhesive Polyester thermoplastic type 30 Annealed copper foil 35 (Gold plating over nickel under plating) Polyester Adhesive 30 Polyester 12 Adhesive Polyester 30 Stiffener Polyester 188 Total 295

* Actual tolerance of the thickness is approximately $\pm 20 \mu$ m.

- 1. This specification is a recommendation for the material configuration of the FPC/FFC (t=0.3 \pm 0.05mm) for the FH40 series connectors.
- 2. Please contact the FPC/FFC manufacturer for the material configurations of their FPC/FFC.



Packaging Specification

•Embossed Carrier Tape Dimensions (Tape width to 24mm max.)



•Embossed Carrier Tape Dimensions (Tape width 32mm min.)



Reel Dimensions



Packaging Specification Dimensions

	specificatio	Dimensi	0115					Unit : mm
Part No.	HRS No.	No. of Contacts	F	G	Н	J	К	L
FH40-10S-0.5SV	580-2104-6	10	16		7.5	8.4	17.4	21.4
FH40-20S-0.5SV	580-2105-9	20	24		11.5	13.4	25.4	29.4
FH40-24S-0.5SV	580-2106-1	24	24		11.5	15.4	25.4	29.4
FH40-30S-0.5SV	580-2108-7	30	32	28.4	14.2	18.4	33.4	37.4
FH40-40S-0.5SV	580-2107-4	40				23.4		
FH40-45S-0.5SV	580-2101-8	45	44	40.4	20.2	25.9	45.4	49.4
FH40-50S-0.5SV	580-2100-5	50				28.4		
FH40-60S-0.5SV	580-2109-0	60				33.4		
FH40-64S-0.5SV	580-2102-0	64	56	52.4	26.2	35.4	57.4	61.4
FH40-80S-0.5SV	580-2103-3	80				43.4		

Note 1 : Tape and reel packaging (1,000 pcs/reel).

Temperature Profile



Solder method	: Reflow, IR/hot air	
Environment:	: Room air	
Solder composition : Paste, 96.5%Sn/3%Ag/0.5%Cu		
	(Senju Metal Industry, Co., Ltd.'s	
	Part Number : M705-GRN360-K2-V)	
Test board	: Glass epoxy 30mm×66mm×0.8mm thick	
Land dimensions	: 0.35mm×1.2mm	
Metal mask	: 0.25×1.0×0.15mm thick	

The temperature profiles shown are based on the above conditions.

In individual applications the actual temperature may vary, depending on solder paste type, volume / thickness and board size / thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

Connector Operation and Precautions

